

### Z Power LED - Z5-M4

S1W0-3535xxxx03-00000000-00004





## **Product Brief**

### **Description**

- The Z-Power series is designed for high flux output applications with high current operation capability.
- It incorporates state of the art SMD design and low thermal resistant material.
- The Z Power LED is ideal light sources for directional lighting applications such as Spot Lights, various outdoor applications, automotive lightings and high performance torches.

### **Features and Benefits**

- High Lumen Output and Efficacy
- Designed for high current operation
- Low Thermal Resistance
- ANSI compliant Binning
- Ceramic package

### **Key Applications**

- Architectural
- Industrial
- Outdoor area
- Exterior Lighting
- Commercial

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**Table 1. Product Selection (Order Code Table)** 

Reference Codez	Color	Nominal CCT	Part Number	CRI
Reference Codez	Color	Rollilla CCI Fait Nulliber		Min
		6500K	S1W0-3535657003-00000000-00004	
SZ5-M4-W0-C7	Cool White	5700K	S1W0-3535577003-00000000-00004	
		5000K	S1W0-3535507003-00000000-00004	
SZ5-M4-WN-C7	Neutral White	4000K	S1W0-3535407003-00000000-00004	70
		3500K	S1W0-3535357003-00000000-00004	-
SZ5-M4-WW-C7	Warm White	3000K	S1W0-3535307003-00000000-00004	
		2700K	S1W0-3535277003-00000000-00004	
		6500K	S1W0-3535658003-00000000-00004	
SZ5-M4-W0-C8	Cool White	5700K	S1W0-3535578003-00000000-00004	
		5000K	S1W0-3535508003-00000000-00004	
SZ5-M4-WN-C8	Neutral White	4000K	S1W0-3535408003-00000000-00004	80
		3500K	S1W0-3535358003-00000000-00004	
SZ5-M4-WW-C8	Warm White	3000K	S1W0-3535308003-00000000-00004	
		2700K	S1W0-3535278003-00000000-00004	
		6500K	S1W0-3535659003-00000000-00004	
SZ5-M4-W0-C9	Cool White	5700K	S1W0-3535579003-00000000-00004	
		5000K	S1W0-3535509003-00000000-00004	
SZ5-M4-WN-C9	Neutral White	4000K	S1W0-3535409003-00000000-00004	90
		3500K	S1W0-3535359003-00000000-00004	
SZ5-M4-WW-C9	Warm White	3000K	S1W0-3535309003-00000000-00004	
		2700K	S1W0-3535279003-00000000-00004	-



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## **Performance Characteristics**

### **Table 2. Characteristics**

Parameter	Symbol		Unit		
Farameter	Symbol	Min.	Тур.	Max. <sup>[3]</sup>	Offic
Forward Current [1]	I <sub>F</sub>	-	700	2000	mA
Forward Voltage (@700mA, 85°C)	$V_{F}$	-	-	2.95	V
Junction Temperature	T <sub>j</sub>	-	-	150	°C
Viewing angle	θ		120		degree
Thermal resistance (J to S) [2]	$R\theta_{J-S}$	-	3	-	K/W
ESD Sensitivity(HBM)		Class 3	B JEDEC JS-0	01-2017	

### Notes:

- (1) At Junction Temperature 85°C condition.
- (2)  $R\theta_{J-S}$  is tested at 700mA.
- (3) It is recommended to use it in the condition that the reliability is secured within the Max value.
- Thermal resistance can be increased substantially depending on the heat sink design/operating condition, and the maximum possible driving current will decrease accordingly.

Fig 1. Color Spectrum

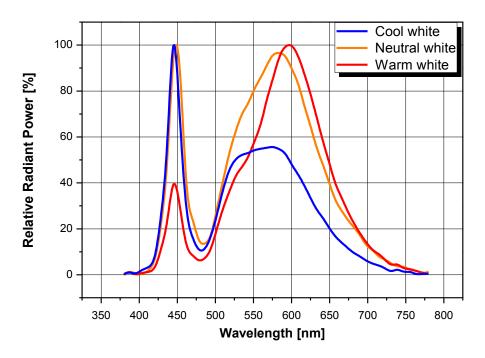


Fig 2. Typical Spatial Distribution

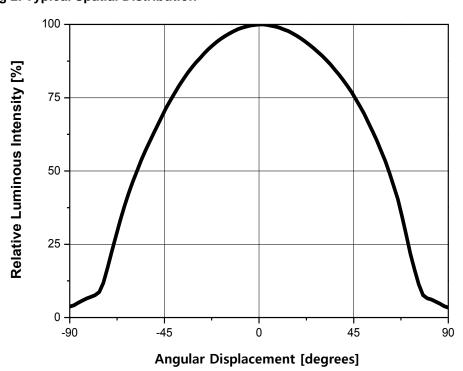


Fig 3. Forward Voltage vs. Forward Current, T<sub>i</sub>=85°C

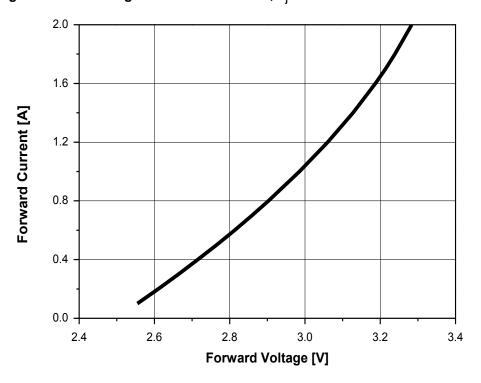


Fig 4. Forward Current vs. Relative Luminous Flux, T<sub>i</sub>=85°C

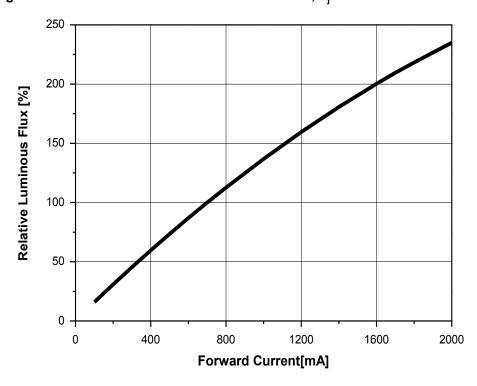


Fig 5. Forward Current vs. CIE X, Y Shift, T<sub>i</sub>=85°C

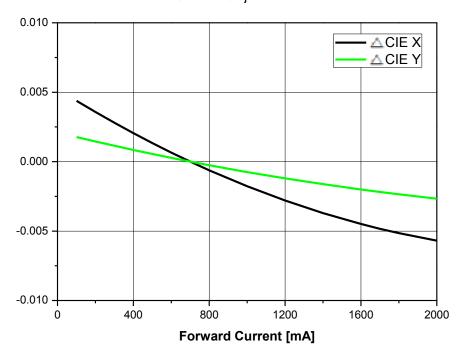


Fig 6. Junction Temp. vs. CIE X, Y Shift, I<sub>F</sub>=700mA

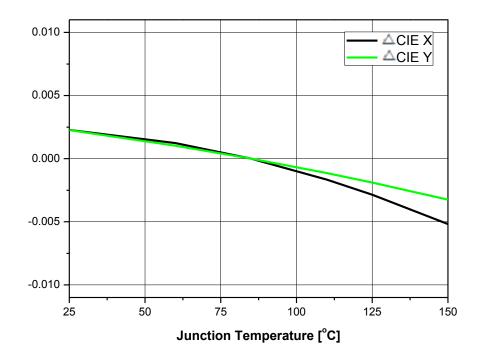


Fig 7. Relative Light Output vs. Junction Temperature, I<sub>F</sub>=700mA

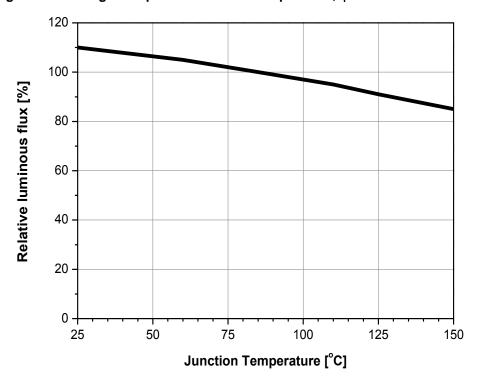


Fig 8. Relative Forward Voltage vs. Junction Temperature, I<sub>F</sub>=700mA

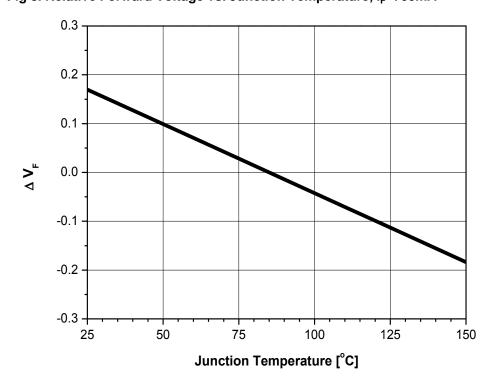
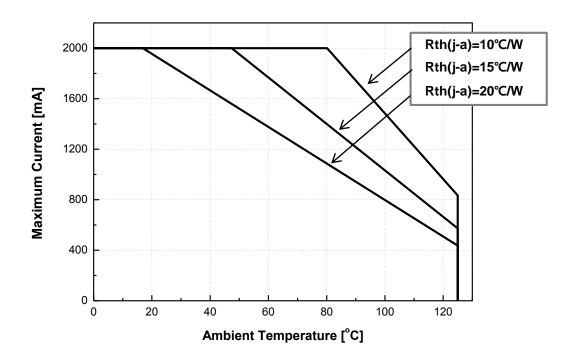


Fig 9. Maximum Forward Current vs. Ambient Temperature, T<sub>i</sub>(max.)=150°C



## **Performance Characteristics**

Fig 10-1. Current vs µmol/s characteristics\_5000K

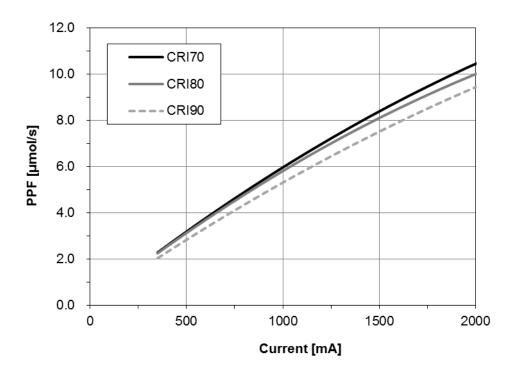
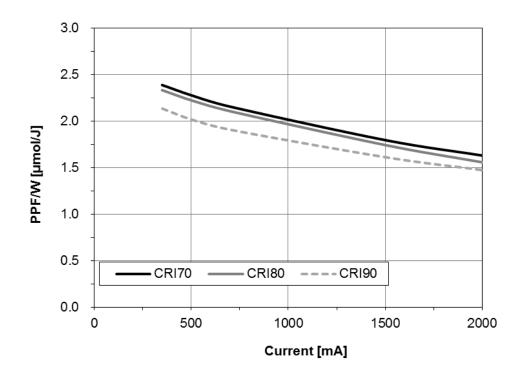


Fig 10-2. Current vs µmol/J characteristics\_5000K



## **Performance Characteristics**

Fig 11-1. Current vs µmol/s characteristics\_4000K

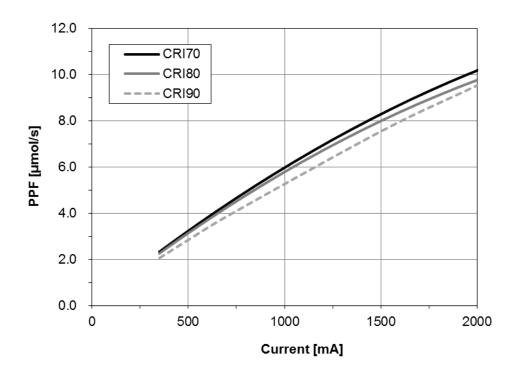
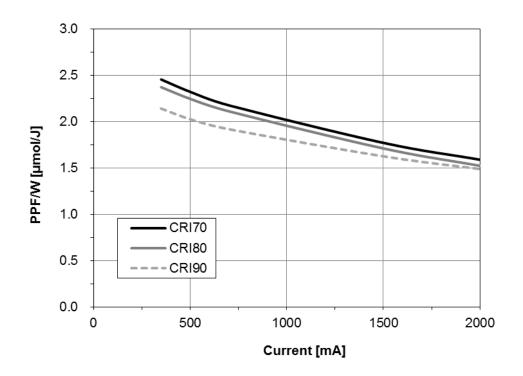


Fig 11-2. Current vs µmol/J characteristics\_4000K



## **Performance Characteristics**

Fig 12-1. Current vs µmol/s characteristics\_3000K

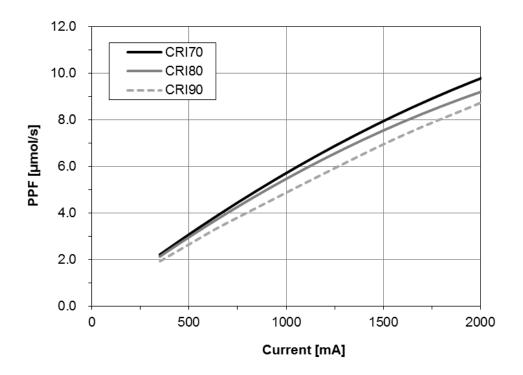
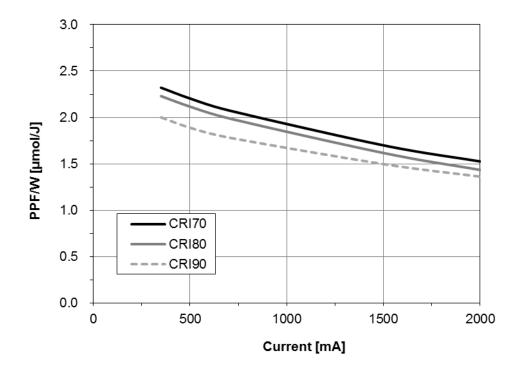


Fig 12-2. Current vs µmol/J characteristics\_3000K



## **Color Bin Structure**

Table 3. CRI70, Bin Code description, I<sub>F</sub>=700mA, T<sub>i</sub>=85°C

Luminous Flux [lm]			Туріса	Typical Forward Voltage [V <sub>F</sub> ]			
Bin Code	Min.	Max.	Bin Code	Min.	Max.		
W4	285	299		2.75	•		
W5	299	313	_				
W6	313	327	_		0.05		
W7	327	340	— G		2.95		
W8	340	355					
W9	355	370					

Table 4. CRI70, Flux Rank Distribution

Available Rank

ССТ	CIE		Flux Rank								
6000 ~ 7000K	Α	W3	W4	W5	W6	W7	W8	W9			
5300 ~ 6000K	В	W3	W4	W5	W6	W7	W8	W9			
4700 ~ 5300K	С	W3	W4	W5	W6	W7	W8	W9			
3700 ~ 4200K	Е	W3	W4	W5	W6	W7	W8	W9			
3200 ~ 3700K	F	W3	W4	W5	W6	W7	W8	W9			
2900 ~ 3200K	G	W3	W4	W5	W6	W7	W8	W9			
2600 ~ 2900K	Н	W3	W4	W5	W6	W7	W8	W9			

**Notes:** (1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.

Color coordinate :  $\pm 0.005$ , CCT  $\pm 5\%$  tolerance.

- (2) Seoul Semiconductor maintains a tolerance of  $\pm 7\%$  on flux and power measurements.
- (3)  $\Phi_{\text{V}}$  is the total luminous flux output as measured with an integrating sphere.
- (4) Tolerance is  $\pm 2.0$  on CRI measurements.
- (5) Tolerance is  $\pm 0.06V$  on forward voltage measurements.

## **Color Bin Structure**

Table 5. CRI80, Bin Code description, I<sub>F</sub>=700mA, T<sub>i</sub>=85°C

	Luminous Flux [lm]	ı	Туріса	Typical Forward Voltage [V <sub>F</sub> ]			
Bin Code	Min.	Max.	Bin Code	Min.	Max.		
W2	254	271					
W3	271	285	_				
W4	285	299	_				
W5	299	313	 G	2.75	2.95		
W6	313	327	_				
W7	327	340	_				
W8	340	340	_				

### Table 6. CRI80, Flux Rank Distribution

Available Rank

ССТ	CIE		Flux Rank								
6000 ~ 7000K	Α	W2	W3	W4	W5	W6	W7	W8			
5300 ~ 6000K	В	W2	W3	W4	W5	W6	W7	W8			
4700 ~ 5300K	С	W2	W3	W4	W5	W6	W7	W8			
3700 ~ 4200K	Е	W2	W3	W4	W5	W6	W7	W8			
3200 ~ 3700K	F	W2	W3	W4	W5	W6	W7	W8			
2900 ~ 3200K	G	W2	W3	W4	W5	W6	W7	W8			
2600 ~ 2900K	Н	W2	W3	W4	W5	W6	W7	W8			

**Notes:** (1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.

Color coordinate :  $\pm 0.005$ , CCT  $\pm 5\%$  tolerance.

- (2) Seoul Semiconductor maintains a tolerance of  $\pm 7\%$  on flux and power measurements.
- (3)  $\Phi_{\text{V}}$  is the total luminous flux output as measured with an integrating sphere.
- (4) Tolerance is  $\pm 2.0$  on CRI measurements.
- (5) Tolerance is  $\pm 0.06V$  on forward voltage measurements.

## **Color Bin Structure**

Table 7. CRI90, Bin Code description, I<sub>F</sub>=700mA, T<sub>i</sub>=85°C

	Luminous Flux [lm	Туріса	Typical Forward Voltage [V <sub>F</sub> ]			
Bin Code	Min.	Max.	Bin Code	Min.	Max.	
V1	195	208				
V2	208	223	_	2.75	2.95	
V3	223	237	_			
W1	237	254	_			
W2	254	271	— G			
W3	271	285				
W4	285	299	_			
			_			

### Table 8. CRI90, Flux Rank Distribution

Available Rank

ССТ	CIE		Flux Rank								
6000 ~ 7000K	Α	V1	V2	V3	W1	W2	W3	W4			
5300 ~ 6000K	В	V1	V2	V3	W1	W2	W3	W4			
4700 ~ 5300K	С	V1	V2	V3	W1	W2	W3	W4			
3700 ~ 4200K	Е	V1	V2	V3	W1	W2	W3	W4			
3200 ~ 3700K	F	V1	V2	V3	W1	W2	W3	W4			
2900 ~ 3200K	G	V1	V2	V3	W1	W2	W3	W4			
2600 ~ 2900K	Н	V1	V2	V3	W1	W2	W3	W4			

**Notes:** (1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.

Color coordinate :  $\pm 0.005$ , CCT  $\pm 5\%$  tolerance.

- (2) Seoul Semiconductor maintains a tolerance of  $\pm 7\%$  on flux and power measurements.
- (3)  $\Phi_{\text{V}}$  is the total luminous flux output as measured with an integrating sphere.
- (4) Tolerance is  $\pm 2.0$  on CRI measurements.
- (5) Tolerance is  $\pm 0.06V$  on forward voltage measurements.

## **Performance Characteristics**

**Table 9. Brightness Groups** 

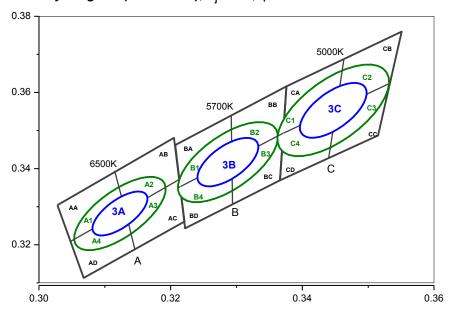
Part no	no CRI CCT Rank		Rank		lux n]	Pi [μm	PF ol/s]	PPF/W [µmol/J]
				min	max	min	max	typ
			W6	299	313	3.90	4.09	1.98
SZ5-M4-W0-C7	70	5000K	W7	313	327	4.09	4.27	2.07
			W8	327	340	4.27	4.44	2.16
			W6	299	313	3.87	4.05	1.97
SZ5-M4-WN-C7	70	4000K	W7	313	327	4.05	4.23	2.06
			W8	327	340	4.23	4.40	2.14
			W4	285	299	3.73	3.91	1.89
SZ5-M4-WW-C7	70	3000K	W5	299	313	3.91	4.09	1.99
			W6	313	327	4.09	4.28	2.08
			W5	299	313	4.00	4.19	2.03
SZ5-M4-W0-C8	80	5000K	W6	313	327	4.19	4.38	2.13
			W7	327	340	4.38	4.55	2.22
			W5	299	313	3.97	4.16	2.02
SZ5-M4-WN-C8	80	4000K	W6	313	327	4.16	4.35	2.11
			W7	327	340	4.35	4.52	2.20
			W3	271	285	3.72	3.92	1.90
SZ5-M4-WW-C8	80	3000K	W4	285	299	3.92	4.11	1.99
			W5	299	313	4.11	4.30	2.09
			W1	237	254	3.63	3.89	1.86
SZ5-M4-W0-C9	90	5000K	W2	254	271	3.89	4.15	1.99
			W3	271	285	4.15	4.36	2.11
			V3	223	237	3.55	3.77	1.81
SZ5-M4-WN-C9	90	4000K	W1	237	254	3.77	4.04	1.94
			W2	254	271	4.04	4.31	2.07
			V1	195	208	3.15	3.36	1.62
SZ5-M4-WW-C9	90	3000K	V2	208	223	3.36	3.61	1.73
			V3	223	237	3.61	3.83	1.84

**Notes:** (1) Seoul Semiconductor maintains a tolerance of  $\pm 7\%$  on flux and power measurements.

(2) Photosynthetic Photon Flux includes wavelengths between 400 and 700 nm

## **Color Bin Structure**

CIE Chromaticity Diagram (Cool white), T<sub>j</sub>=85°C, I<sub>F</sub>=700mA

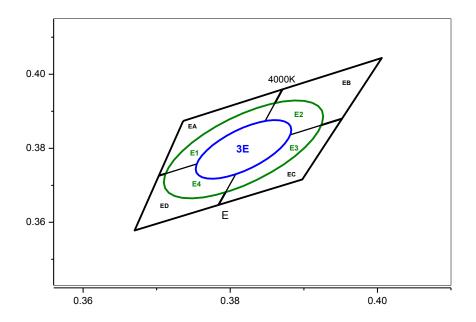


6500	K 3Step	5700	K 3Step	5000K 3Step		
	3A		3B	3C		
Center point	0.3123 : 0.3282	Center point	0.3287 : 0.3417	Center point	0.3447 : 0.3553	
Major Axis a	0.0066	Major Axis a	0.0072	Major Axis a	0.0081	
Minor Axis b	0.0027	Minor Axis b	0.0032	Minor Axis b	0.0035	
Ellipse Rotation Angle	58	Ellipse Rotation Angle	59	Ellipse Rotation Angle	60	
6500	K 5Step	5700	K 5Step	5000K 5Step		
	5A		5B	5C		
Center point	0.3123 : 0.3282	Center point	0.3287 : 0.3417	Center point	0.3447 : 0.3553	
Major Axis a	0.0110	Major Axis a	0.0119	Major Axis a	0.0135	
Minor Axis b	0.0045	Minor Axis b	0.0052	Minor Axis b	0.0059	
Ellipse Rotation Angle	58	Ellipse Rotation Angle	59	Ellipse Rotation Angle	60	

Α	Α	A	В	А	С	Α	D
CIE X	CIE Y						
0.3028	0.3304	0.3115	0.3393	0.3131	0.3290	0.3048	0.3209
0.3048	0.3209	0.3131	0.3290	0.3146	0.3187	0.3068	0.3113
0.3131	0.329	0.3213	0.3371	0.3221	0.3261	0.3146	0.3187
0.3115	0.3393	0.3205	0.3481	0.3213	0.3371	0.3131	0.329
В	A	В	В	В	C	В	D
CIE X	CIE Y						
0.3207	0.3462	0.3292	0.3539	0.3293	0.3423	0.3215	0.3353
0.3215	0.3353	0.3293	0.3423	0.3294	0.3306	0.3222	0.3243
0.3293	0.3423	0.3371	0.3493	0.3366	0.3369	0.3294	0.3306
0.3292	0.3539	0.3376	0.3616	0.3371	0.3493	0.3293	0.3423
С	A	C	В	C	C	С	D
CIE X	CIE Y						
0.3376	0.3616	0.3463	0.3687	0.3452	0.3558	0.3371	0.3493
0.3371	0.3493	0.3452	0.3558	0.344	0.3428	0.3366	0.3369
0.3452	0.3558	0.3533	0.3624	0.3514	0.3487	0.344	0.3428
0.3463	0.3687	0.3551	0.376	0.3533	0.3624	0.3452	0.3558

## **Color Bin Structure**

## CIE Chromaticity Diagram (Neutral White), T<sub>i</sub>=85°C, I<sub>F</sub>=700mA



### 4000K 3Step

3E					
Center point	0.3818 : 0.3797				
Major Axis a	0.0094				
Minor Axis b	0.0041				
Ellipse	53.4				
Rotation Angle	55.4				

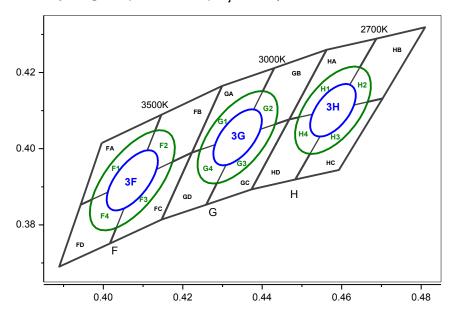
### 4000K 5Step

5E					
Center point	0.3818 : 0.3797				
Major Axis a	0.0157				
Minor Axis b	0.0067				
Ellipse	53				
Rotation Angle	55				

E	ĒΑ	E	В	E	c	E	D
CIE X	CIE Y						
0.3736	0.3874	0.3871	0.3959	0.3828	0.3803	0.3703	0.3726
0.3703	0.3726	0.3828	0.3803	0.3784	0.3647	0.3670	0.3578
0.3828	0.3803	0.3952	0.3880	0.3898	0.3716	0.3784	0.3647
0.3871	0.3959	0.4006	0.4044	0.3952	0.3880	0.3828	0.3803

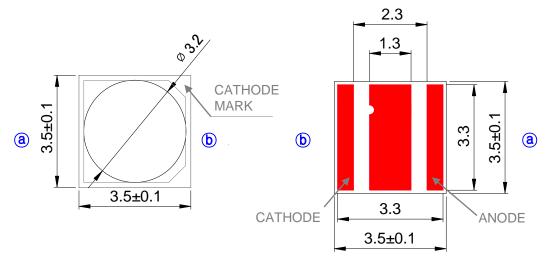
## **Color Bin Structure**

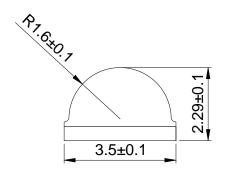
## CIE Chromaticity Diagram (Warm White), T<sub>i</sub>=85°C, I<sub>F</sub>=700mA

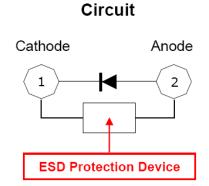


Center point	3500K 3Step 3000K 3Step		2700K 3Step						
Major Axis a         0.0093         Major Axis a         0.0086         Major Axis a         0.0080           Minor Axis b         0.0042         Minor Axis b         0.0042         Minor Axis b         0.0041           Ellipse Rotation Angle         54         Ellipse Rotation Angle         54         Ellipse Rotation Angle         54           SF         3000K 5Step         3000K 5Step         2700K 5Step         5H           Center point 0.4073 : 0.3917         Center point 0.4338 : 0.4030         Center point 0.4578 : 0.4101           Major Axis a 0.0155         Major Axis a 0.0142         Major Axis a 0.0132           Minor Axis b 0.0068         Minor Axis b 0.0068         Minor Axis b 0.0068           Ellipse Rotation Angle         54         Ellipse Rotation Angle         54           FB         FC         FD           CIE X CIE Y CIE X CI		3F		3 <b>G</b>			3H		
Minor Axis b   0.0042	Center point	0.4073 :	0.3917	Center point	0.4338 : 0.4030	Center po	int 0.4	4578 : 0.4101	
Ellipse Rotation Angle   54	Major Axis a	0.00	93	Major Axis a	0.0086	Major Axi	s a	0.0080	
Rotation Angle   S4	Minor Axis b	0.00	42	Minor Axis b	0.0042	Minor Axi	s b	0.0041	
Center point         0.4073 : 0.3917         Center point         0.4338 : 0.4030         Center point         0.4578 : 0.4101           Major Axis a         0.0155         Major Axis a         0.0142         Major Axis a         0.0132           Minor Axis b         0.0068         Minor Axis b         0.0068         Minor Axis b         0.0068           Ellipse Rotation Angle         54         Ellipse Rotation Angle         54         Ellipse Rotation Angle         54           CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y           0.3996         0.4015         0.4146         0.4089         0.4082         0.3920         0.3943         0.3853           0.3943         0.3853         0.4082         0.3920         0.4017         0.3751         0.3889         0.3690           0.4082         0.392         0.4223         0.3990         0.4147         0.3814         0.4017         0.3751           0.4146         0.4089         0.4223         0.3990         0.4147         0.3814         0.4017         0.3751           0.4146         0.4089         0.4229         0.4165         0.4223         0.3990         0.4082         0.3920      <	•	54		•	54			54	
Center point         0.4073: 0.3917         Center point         0.4338: 0.4030         Center point         0.4578: 0.4101           Major Axis a         0.0155         Major Axis a         0.0142         Major Axis a         0.0132           Minor Axis b         0.0068         Minor Axis b         0.0068         Minor Axis b         0.0068           Ellipse Rotation Angle         54         Ellipse Rotation Angle         54         Ellipse Rotation Angle         54           CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y           0.3996         0.4015         0.4146         0.4089         0.4082         0.3920         0.3943         0.3853           0.3943         0.3853         0.4082         0.3990         0.4147         0.3751         0.3889         0.3690           0.4082         0.392         0.4223         0.3990         0.4147         0.3814         0.4017         0.3751           0.4146         0.4089         0.4223         0.3990         0.4147         0.3814         0.4017         0.3751           0.4146         0.4089         0.4299         0.4165         0.4223         0.3990         0.4082         0.3920	3500	K 5Step		3000	K 5Step	2	700K 5	Step	
Major Axis a         0.0155         Major Axis a         0.0142         Major Axis a         0.0132           Minor Axis b         0.0068         Minor Axis b         0.0068         Minor Axis b         0.0068           Ellipse Rotation Angle         54         Ellipse Rotation Angle         54         Ellipse Rotation Angle         54           FC         FD           CIE X         CIE Y         CIE X         CIE Y <td< td=""><td></td><td>5F</td><td></td><td></td><td>5G</td><td></td><td>5H</td><td></td></td<>		5F			5G		5H		
Minor Axis b         0.0068         Minor Axis b         0.0068         Minor Axis b         0.0068         Minor Axis b         0.0068         Ellipse Rotation Angle         54         FD	Center point	0.4073 :	0.3917	Center point	0.4338 : 0.4030	Center po	int 0.4	4578 : 0.4101	
Ellipse Rotation Angle         54         Ellipse Rotation Angle         54         Ellipse Rotation Angle         54           FA         FB         FC         FD           CIE X         CIE Y	Major Axis a	0.01	55	Major Axis a	0.0142	Major Axi	s a	0.0132	
Rotation Angle         S4         FD           CIE X         CIE Y         CIE Y         CIE Y         CIE Y         CIE Y         CIE X         CIE Y         CIE X <th< td=""><td>Minor Axis b</td><td>0.00</td><td>68</td><td></td><td>0.0068</td><td>Minor Axi</td><td>s b</td><td>0.0068</td></th<>	Minor Axis b	0.00	68		0.0068	Minor Axi	s b	0.0068	
CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y           0.3996         0.4015         0.4146         0.4089         0.4082         0.3920         0.3943         0.3853           0.3943         0.3853         0.4082         0.3920         0.4017         0.3751         0.3889         0.3690           0.4082         0.392         0.4223         0.3990         0.4147         0.3814         0.4017         0.3751           0.4146         0.4089         0.4299         0.4165         0.4223         0.3990         0.4082         0.3920           GA         GB         GC         GD           CIE X         CIE Y         0.3853         0.4147         0.3814           0.4223         0.3990         0.4345         0.4033         0.4259         0.3853         0.4147         0.3814           0.4345 <td>•</td> <td>54</td> <td></td> <td>•</td> <td>54</td> <td>•</td> <td></td> <td>54</td>	•	54		•	54	•		54	
CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y           0.3996         0.4015         0.4146         0.4089         0.4082         0.3920         0.3943         0.3853           0.3943         0.3853         0.4082         0.3920         0.4017         0.3751         0.3889         0.3690           0.4082         0.392         0.4223         0.3990         0.4147         0.3814         0.4017         0.3751           0.4146         0.4089         0.4299         0.4165         0.4223         0.3990         0.4082         0.3920           GA         GB         GC         GD           CIE X         CIE Y         0.3853         0.4147         0.3814           0.4223         0.3990         0.4345         0.4033         0.4259         0.3853         0.4147         0.3814           0.4345 <td>FA</td> <td></td> <td></td> <td>FB</td> <td>FC</td> <td></td> <td></td> <td>FD</td>	FA			FB	FC			FD	
0.3943         0.3853         0.4082         0.3920         0.4017         0.3751         0.3889         0.3690           0.4082         0.392         0.4223         0.3990         0.4147         0.3814         0.4017         0.3751           0.4146         0.4089         0.4299         0.4165         0.4223         0.3990         0.4082         0.3920           GA         GB         GC         GD           CIE X         CIE Y         0.4345         0.4033         0.4223         0.3999         0.4345         0.4033         0.4259         0.3853         0.4147         0.3814         0.4345         0.4033         0.4259         0.3853         0.4147         0.3853         0.4259         0.3853         0.4259         0.3853         0.4259         0.3853         0.4259         0.3853         0.4259         0.4345         0.4077         0.4345         0.4033         0.4259         0.426	-	CIE Y	CIE 2			CIE Y	CIE X		
0.4082         0.392         0.4223         0.3990         0.4147         0.3814         0.4017         0.3751           0.4146         0.4089         0.4299         0.4165         0.4223         0.3990         0.4082         0.3920           GA         GB         GC         GD           CIE X         CIE Y         CIE X         CIE Y <td>0.3996</td> <td>0.4015</td> <td>0.414</td> <td>6 0.4089</td> <td>0.4082</td> <td>0.3920</td> <td>0.3943</td> <td>0.3853</td>	0.3996	0.4015	0.414	6 0.4089	0.4082	0.3920	0.3943	0.3853	
0.4146         0.4089         0.4299         0.4165         0.4223         0.3990         0.4082         0.3920           GA         GB         GC         GD           CIE X         CIE Y         0.3990         0.4345         0.4033         0.4259         0.3853         0.4147         0.3814           0.4345         0.4033         0.4468         0.4077         0.4373         0.3893         0.4259         0.3853           0.4430         0.4212         0.4562         0.426         0.4468         0.4077         0.4345         0.4033           HA         HB         HC         HD         HD           CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y           0.4562         0.4269         0.4585         0.4104         0.4468         0.4077           0.4562         0.4269         0.4585         0.4104         0.4468         0.4077           0.4468         0.4077	0.3943	0.3853	0.408	2 0.3920	0.4017	0.3751	0.3889	0.3690	
GA         GB         GC         GD           CIE X         CIE Y         CIE X         CIE X         CIE X         CIE X         CIE X         CIE X         CIE Y         CIE X         CIE X         CIE Y         CIE X	0.4082	0.392	0.422	3 0.3990	0.4147	0.3814	0.4017	0.3751	
CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y           0.4299         0.4165         0.4430         0.4212         0.4345         0.4033         0.4223         0.399           0.4223         0.3990         0.4345         0.4033         0.4259         0.3853         0.4147         0.3814           0.4345         0.4033         0.4468         0.4077         0.4373         0.3893         0.4259         0.3853           0.4430         0.4212         0.4562         0.426         0.4468         0.4077         0.4345         0.4033           HA         HB         HC         HD           CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y           0.4562         0.426         0.4289         0.4585         0.4104         0.4468         0.4077           0.4468         0.4077         0.4585         0.4104         0.4468         0.4077         0.4373         0.3893           0.4585         0.4104         0.4483         0.3919         0.4373         0.3893           0.4585         0.4104         0.4583         0.3944         0.4483	0.4146	0.4089	0.429	9 0.4165	0.4223	0.3990	0.4082	0.3920	
0.4299         0.4165         0.4430         0.4212         0.4345         0.4033         0.4223         0.399           0.4223         0.3990         0.4345         0.4033         0.4259         0.3853         0.4147         0.3814           0.4345         0.4033         0.4468         0.4077         0.4373         0.3893         0.4259         0.3853           0.4430         0.4212         0.4562         0.426         0.4468         0.4077         0.4345         0.4033           HA         HB         HC         HD           CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y           0.4562         0.426         0.4687         0.4289         0.4585         0.4104         0.4468         0.4077           0.4468         0.4077         0.4585         0.4104         0.4483         0.3919         0.4373         0.3893           0.4585         0.4104         0.4703         0.4132         0.4593         0.3944         0.4483         0.3919	GA			GB	GC			GD	
0.4223         0.3990         0.4345         0.4033         0.4259         0.3853         0.4147         0.3814           0.4345         0.4033         0.4468         0.4077         0.4373         0.3893         0.4259         0.3853           0.4430         0.4212         0.4562         0.426         0.4468         0.4077         0.4345         0.4033           HA         HB         HC         HD           CIE X         CIE Y         CIE X         CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y         CIE X </td <td>CIE X</td> <td>CIE Y</td> <td>CIE 2</td> <td>CIE Y</td> <td>CIE X</td> <td>CIE Y</td> <td>CIE X</td> <td>CIE Y</td>	CIE X	CIE Y	CIE 2	CIE Y	CIE X	CIE Y	CIE X	CIE Y	
0.4345         0.4033         0.4468         0.4077         0.4373         0.3893         0.4259         0.3853           0.4430         0.4212         0.4562         0.426         0.4468         0.4077         0.4345         0.4033           HA         HB         HC         HD           CIE X         CIE Y         CIE X         CIE X         CIE Y         CIE X         CIE X         CIE X         CIE X         CIE X         CIE X         CIE X <td>0.4299</td> <td>0.4165</td> <td>0.443</td> <td>0 0.4212</td> <td>0.4345</td> <td>0.4033</td> <td>0.4223</td> <td>0.399</td>	0.4299	0.4165	0.443	0 0.4212	0.4345	0.4033	0.4223	0.399	
0.4430         0.4212         0.4562         0.426         0.4468         0.4077         0.4345         0.4033           HA         HB         HC         HD           CIE X         CIE Y         O.4562         0.4468         0.4077         0.4585         0.4104         0.4483         0.3919         0.4373         0.3893           0.4585         0.4104         0.4703         0.4132         0.4593         0.3944         0.4483         0.3919	0.4223	0.3990	0.434	5 0.4033	0.4259	0.3853	0.4147	0.3814	
HA         HB         HC         HD           CIE X         CIE Y         CIE X	0.4345	0.4033	0.446	8 0.4077	0.4373	0.3893	0.4259	0.3853	
CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y         CIE X         CIE Y           0.4562         0.426         0.4687         0.4289         0.4585         0.4104         0.4468         0.4077           0.4468         0.4077         0.4585         0.4104         0.4483         0.3919         0.4373         0.3893           0.4585         0.4104         0.4703         0.4132         0.4593         0.3944         0.4483         0.3919	0.4430	0.4212	0.456	2 0.426	0.4468	0.4077	0.4345	0.4033	
0.4562         0.426         0.4687         0.4289         0.4585         0.4104         0.4468         0.4077           0.4468         0.4077         0.4585         0.4104         0.4483         0.3919         0.4373         0.3893           0.4585         0.4104         0.4703         0.4132         0.4593         0.3944         0.4483         0.3919	HA			HB	HC			HD	
0.4468         0.4077         0.4585         0.4104         0.4483         0.3919         0.4373         0.3893           0.4585         0.4104         0.4703         0.4132         0.4593         0.3944         0.4483         0.3919	CIE X	CIE Y	CIE 2	K CIE Y	CIE X	CIE Y	CIE X	CIE Y	
0.4585 0.4104 0.4703 0.4132 0.4593 0.3944 0.4483 0.3919	0.4562	0.426	0.468	7 0.4289	0.4585	0.4104	0.4468	0.4077	
	0.4468	0.4077	0.458	5 0.4104	0.4483	0.3919	0.4373	0.3893	
0.4687									
	0.4687	0.4289	0.48	1 0.4319	0.4703	0.4132	0.4585	0.4104	

## **Mechanical Dimensions**





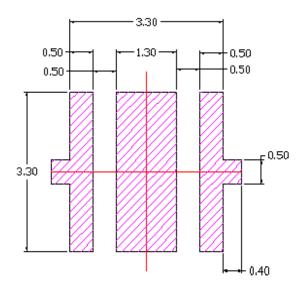


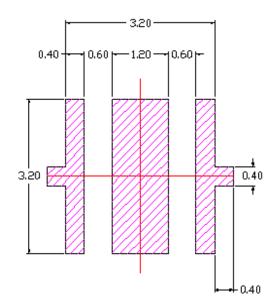
(1) All dimensions are in millimeters.

(2) Scale: none

(3) Undefined tolerance is  $\pm 0.1 \text{mm}$ 

## **Recommended Solder Pad**





Recommended PCB Solder Pad

Recommended Stencil Pattern

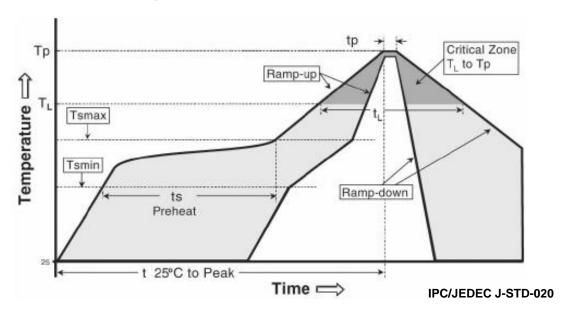
(1) All dimensions are in millimeters.

(2) Scale: none

(3) This drawing without tolerances are for reference only.

(4) Undefined tolerance is  $\pm 0.1$ mm.

# **Reflow Soldering Characteristics**

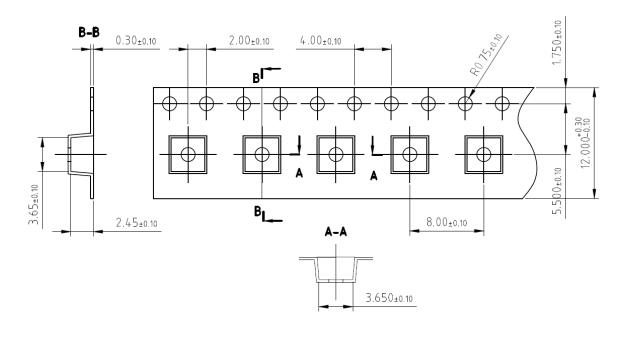


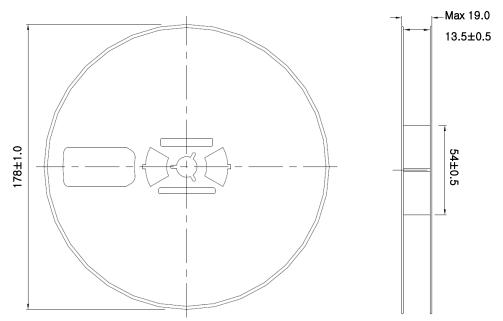
Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (Tsmax to Tp)	3° C/second max.	3° C/second max.
Preheat - Temperature Min (Tsmin) - Temperature Max (Tsmax) - Time (Tsmin to Tsmax) (ts)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-180 seconds
Time maintained above: - Temperature (TL) - Time (tL)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak Temperature (Tp)	215℃	260℃
Time within 5°C of actual Peak Temperature (tp)2	10-30 seconds	20-40 seconds
Ramp-down Rate	6 °C/second max.	6 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

### Caution

- (1) Reflow soldering is recommended not to be done more than two times. In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
- (2) Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
- (3) Die slug is to be soldered.
- (4) When soldering, do not put stress on the LEDs during heating.
- (5) After soldering, do not warp the circuit board.

# **Emitter Tape & Reel Packaging**



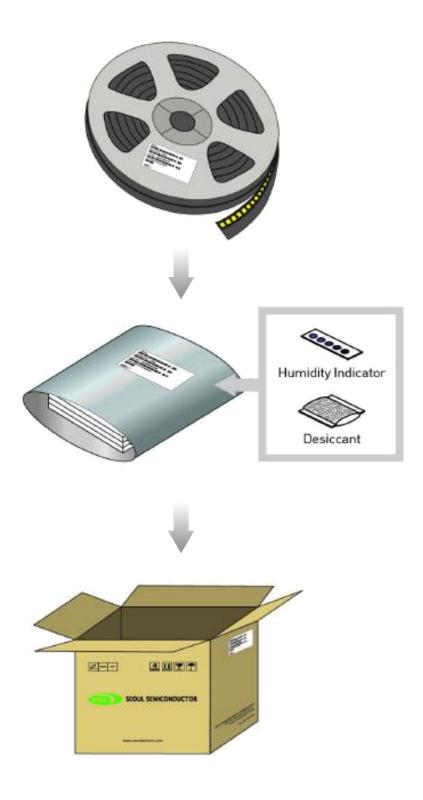


### Notes:

### UNIT: mm

- 1. Quantity: 900pcs/Reel
- 2. Cumulative Tolerance : Cumulative Tolerance/10 pitches to be  $\pm 0.2$ mm
- 3. Adhesion Strength of Cover Tape: Adhesion strength to be 10-60g when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape
- 4. Package: P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package

# **Packaging Information**



## **Product Nomenclature**

Table 10. Part Numbering System:

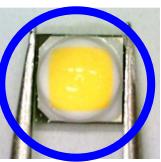
Part Number Code	Description	Part Number	Value
<b>X</b> <sub>1</sub>	Company	S	Seoul Semiconductor
X <sub>2</sub>	Level of Integration	1	Discrete LED
X <sub>3</sub> X <sub>4</sub>	Technology	Wo	General White
X <sub>5</sub> X <sub>6</sub> X <sub>7</sub> X <sub>8</sub>	Dimension	3535	
X <sub>9</sub> X <sub>10</sub>	ССТ	40	
X <sub>11</sub> X <sub>12</sub>	CRI	70	
X <sub>13</sub> X <sub>14</sub>	Vf	03	
X <sub>15</sub> X <sub>16</sub> X <sub>17</sub>	Characteristic code Flux Rank	000	
X <sub>18</sub> X <sub>19</sub> X <sub>20</sub>	Characteristic code Vf Rank	000	
X <sub>21</sub> X <sub>22</sub>	X <sub>21</sub> X <sub>22</sub> Characteristic code Color Step		
X <sub>23</sub> X <sub>24</sub>	Туре	00	
X <sub>25</sub> X <sub>26</sub> X <sub>27</sub>	Internal code	004	Z5M4

## **Handling of Silicone Resin for LEDs**

(1) During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.







- (2) In general, LED should only be handled from the side. By the way, this also applies to LED without a silicone sealant, since the surface can also become scratched.
- (3) When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.
- (4) Silicone differs from materials conventionally used for the manufacturing of LEDs. These conditions must be considered during the handling of such devices. Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust. As mentioned previously, the increased sensitivity to dust requires special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components.
- (5) Seoul Semiconductor suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.
- (6) Please do not mold this product into another resin (epoxy, urethane, etc) and do not handle this product with acid or sulfur material in sealed space.
- (7) Avoid leaving fingerprints on silicone resin parts.

## **Precaution for Use**

(1) Storage

To avoid the moisture penetration, we recommend storing LED in a dry box with a desiccant. The recommended storage temperature range is 5°C to 30°C and a maximum humidity of RH50%.

(2) Use Precaution after Opening the Packaging

Use SMD techniques properly when solder the LED as separation of the lens may affect the light output efficiency.

Pay attention to the following:

- a. Recommend conditions after opening the package
  - Sealing / Temperature : 5 ~ 30°C Humidity : less than RH60%
- b. If the package has been opened more than 4 weeks (MSL 2a) or the color of the desiccant changes, components should be dried for 10-24hr at  $65\pm5^{\circ}$ C
- (3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
- (4) Do not rapidly cool device after soldering.
- (5) Components should not be mounted on warped (non coplanar) portion of PCB.
- (6) Radioactive exposure is not considered for the products listed here in.
- (7) Gallium arsenide is used in some of the products listed in this publication. These products are dangerous if they are burned or shredded in the process of disposal. It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed of.
- (8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.
- (9) When the LED are in operation the maximum current should be decided after measuring the package temperature.
- (10) The appearance and specifications of the product may be modified for improvement without notice.
- (11) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.



## **Precaution for Use**

(12) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LED and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.

- (13) Attaching LEDs, do not use adhesives that outgas organic vapor.
- (14) The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.
- (15) LED is sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.
- a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LED may c ause the product to demonstrate unusual characteristics such as:

- Increase in reverse leakage current lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following recommendations are suggested to help minimize the potential for an ESD event. One or more recommended work area suggestions:

- Ionizing fan setup
- ESD table/shelf mat made of conductive materials
- ESD safe storage containers

One or more personnel suggestion options:

- Antistatic wrist-strap
- Antistatic material shoes
- Antistatic clothes

#### Environmental controls:

- Humidity control (ESD gets worse in a dry environment)



## **Precaution for Use**

b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device. The effects from an EOS event can be noticed through product performance like:

- Changes to the performance of the LED package
  (If the damage is around the bond pad area and since the package is completely encapsulated the package may turn on but flicker show severe performance degradation.)
- Changes to the light output of the luminaire from component failure
- Components on the board not operating at determined drive power

Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures. It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred:

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires.
- This damage usually appears due to the thermal stress produced during the EOS event.
- c. To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing:
  - A surge protection circuit
  - An appropriately rated over voltage protection device
  - A current limiting device



## **Company Information**

### Published by

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### **Company Information**

Seoul Semiconductor (www.SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

#### **Legal Disclaimer**

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